



ULTRA-LOW JITTER 2 × 2 CROSSPOINT SWITCH w/CML OUTPUTS AND INTERNAL I/O TERMINATION

Precision Edge™
SY58023U

FEATURES

- **Guaranteed AC performance over temperature and voltage:**
 - >10.7Gbps data throughput
 - <60ps t_r/t_f times
 - <285ps t_{pd} (IN-to-Q)
 - <20ps skew
- **Low jitter:**
 - <10ps_{pp} total jitter (clock)
 - <1ps_{rms} random jitter (data)
 - <10ps_{pp} deterministic jitter (data)
- **Crosstalk induced jitter: <0.7ps_{rms}**
- **Accepts an input signal as low as 100mV**
- **Unique input termination and V_T pin accepts DC-coupled and AC-coupled differential inputs: LVPECL, LVDS, and CML**
- **50Ω source terminated CML outputs**
- **Fully differential inputs/outputs**
- **Power supply 2.5V ±5% and 3.3V ±10%**
- **Industrial -40°C to +85°C temperature range**
- **Available in 16-pin (3mm × 3mm) MLF™ package**



Precision Edge™

DESCRIPTION

The SY58023U is a 2.5V/3.3V precision, high-speed, fully differential CML 2 × 2 crosspoint switch. The SY58023U is optimized to provide two identical output copies with less than 20ps of skew and ultra-low jitter. It can route clock signals as fast as 6GHz or data up to 10.7Gbps.

The differential input includes Micrel's unique, 3-pin input termination architecture that allows the SY58023U to directly interface to LVPECL, LVDS, and CML differential signals (AC- or DC-coupled) as small as 100mV (200mV_{pp}) without any level-shifting or termination resistor networks in the signal path. The CML outputs features 400mV typical swing into 50Ω loads, and provide an extremely fast rise/fall time guaranteed to be less than 60ps.

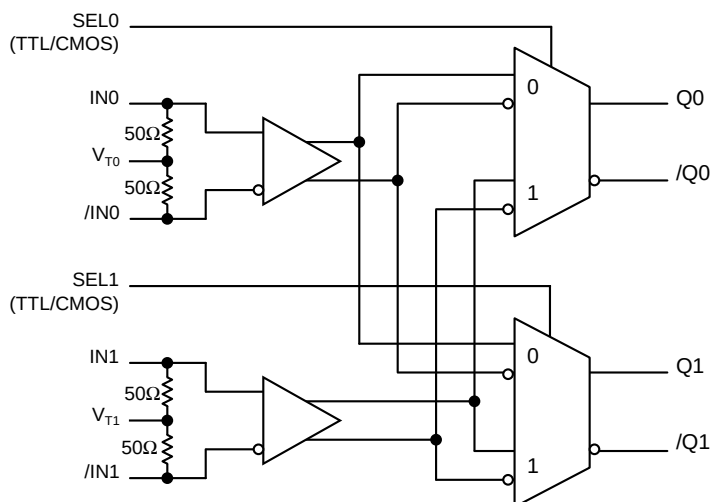
The SY58023U operates from a +2.5V ±5% supply or +3.3V ±10% supply and is guaranteed over the full industrial temperature range (-40°C to +85°C). For applications that require high speed dual CML switches, consider the SY58024U. The SY58023U is part of Micrel's high-speed, Precision Edge™ product line.

Data sheets and support documentation can be found on Micrel's website at www.micrel.com.

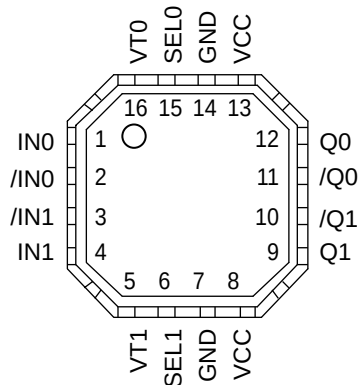
APPLICATIONS

- Gigabit Ethernet data/clock routing
- SONET data/clocking routing
- Switch fabric clock routing
- Redundant switchover
- Backplane redundancy

FUNCTIONAL BLOCK DIAGRAM



PACKAGE/ORDERING INFORMATION



16-Pin MLF™ (MLF-16)

Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58023UMI	MLF-32	Industrial	023U	Sn-Pb
SY58023UMITR ⁽²⁾	MLF-32	Industrial	023U	Sn-Pb
SY58023UMY	MLF-32	Industrial	023U & "Y" designator	Pb Free
SY58023UMYTR ⁽²⁾	MLF-32	Industrial	023U & "Y" designator	Pb Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC electricals only.
2. Tape and Reel.

PIN DESCRIPTION

Pin Number	Pin Name	Pin Function
1, 2, 3, 4	IN0, /IN0, /IN1, IN1	Differential Signal Input: Each pin of this pair internally terminates with 50Ω to the VT pin. Note that this input will default to an indeterminate state if left open. See "Input Interface Applications" section.
16, 5	VT0, VT1	Input Termination Center-Tap: Each input terminates to this pin. The VT pin provides a center-tap for each input (IN, /IN) to a termination network for maximum interface flexibility. See "Input Interface Applications" section.
15, 6	SEL0, SEL1	Select Input: TTL/CMOS select input control that selects inputs IN0, or IN1. Note that this input is internally connected to a $25\text{k}\Omega$ pull-up resistor and will default to a logic High state if left open.
7, 14	GND, (Exposed Pad)	Ground. Exposed pad must be connected to a ground plane that is the same potential as the device ground pin.
8, 13	VCC	Positive Power Supply: Bypass with $0.1\mu\text{F}$ $0.01\mu\text{F}$ low ESR capacitors as close to the pins as possible.
12, 11, 10, 9	Q0, /Q0, /Q1, Q1	CML Differential Output Pairs: Differential buffered output copy of the selected input signal. The CML output swing is typically 400mV across 100Ω . Unused output pairs may be left floating with no impact on jitter. See "CML Output Termination" section.

TRUTH TABLE

SEL0	SEL1	Q0	Q1
L	L	IN0	IN0
L	H	IN0	IN1
H	L	IN1	IN0
H	H	IN1	IN1

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{CC})	–0.5V to +4.0V
Input Voltage (V_{IN})	–0.5V to V_{CC}
CML Output Voltage (V_{OUT})	$V_{CC} - 1.0V$ to $V_{CC} + 0.5V$
Current (V_T)	
Source or Sink Current on V_T pin	$\pm 100mA$
Input Current (V_T)	
Source or Sink Current on IN, /IN	$\pm 50mA$
Lead Temperature (soldering, 20 sec.)	260°C
Storage Temperature (T_S)	–65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage (V_{CC})	+2.375V to +3.60V
Ambient Temperature (T_A)	–40°C to +85°C
Package Thermal Resistance ⁽³⁾	
MLF™ (θ_{JA})	
Still-Air	60°C/W
500lfpm	54°C/W
MLF™ (ψ_{JB})	
Junction-to-board	38°C/W

DC ELECTRICAL CHARACTERISTICS⁽⁴⁾

$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{CC}	Power Supply Voltage	2.5V nominal 3.3V nominal	2.375 3.0	2.5 3.3	2.625 3.60	V
I_{CC}	Power Supply Current	$V_{CC} = \text{max.}$, current through internal 50Ω source termination resistor included.		100	130	mA
V_{IH}	Input HIGH Voltage	IN, /IN; Note 5	$V_{CC} - 1.6$		V_{CC}	V
V_{IL}	Input LOW Voltage	IN, /IN	0		$V_{IH} - 0.1$	V
V_{IN}	Input Voltage Swing	IN, /IN; see Figure 1a.	0.1		1.7	V
V_{DIFF_IN}	Differential Input Swing	IN, /IN; see Figure 1b.	0.2			V
R_{IN}	IN-to- V_T Resistance		40	50	60	Ω
IN to V_T					1.28	V

CML OUTPUT DC ELECTRICAL CHARACTERISTICS⁽⁴⁾

$V_{CC} = +3.3V \pm 10\%$ or $+2.5V \pm 5\%$; $R_L = 100\Omega$ across each output pair; $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OH}	Output HIGH Voltage	Q0, /Q0; Q1, /Q1	$V_{CC} - 0.020$		V_{CC}	V
V_{OUT}	Output Voltage Swing	Q0, /Q0; Q1, /Q1; see Figure 1a.	325	400	500	mV
V_{DIFF_OUT}	Differential Voltage Swing	Q0, /Q0; Q1, /Q1; see Figure 1b.	650	800	1000	mV
R_{OUT}	Output Source Impedance	Q0, /Q0; Q1, /Q1	40	50	60	Ω

Notes:

1. Permanent device damage may occur if ratings in the "Absolute Maximum Ratings" section are exceeded. This is a stress rating only and functional operation is not implied for conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Thermal performance assumes exposed pad is soldered (or equivalent) to the device's most negative potential (GND) on the PCB. θ_{JA} uses 4-layer in still-air, unless otherwise stated.
4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
5. V_{IH} (min.) not lower than 1.2V.

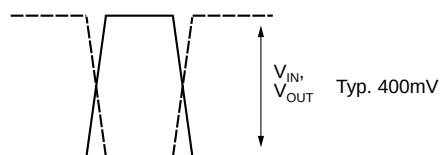
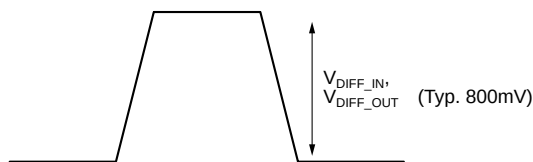
AC ELECTRICAL CHARACTERISTICS⁽⁶⁾

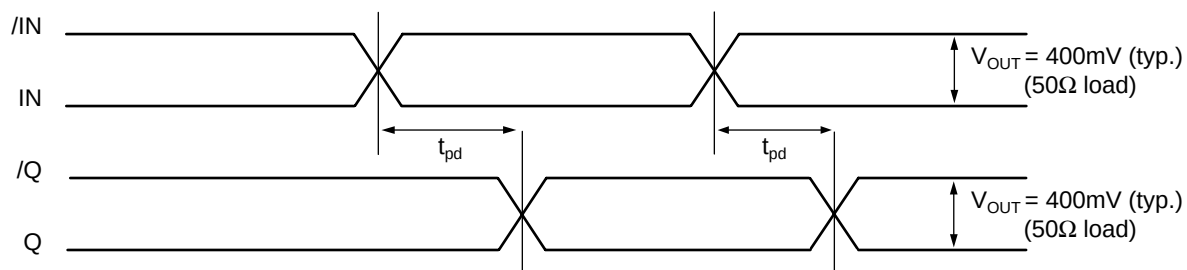
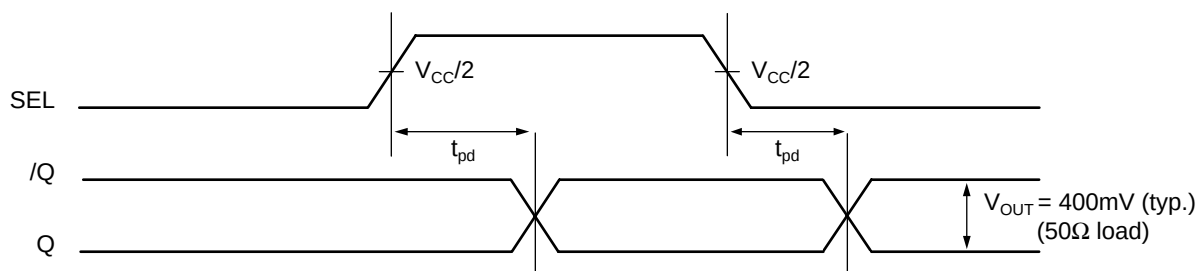
$V_{CC} = 2.5V \pm 5\%$ or $3.3V \pm 10\%$; $R_L = 100\Omega$ across each output pair; $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
f_{MAX}	Maximum Operating Frequency	$V_{IN} \geq 100mV$; $V_{OUT} \geq 200mV$ Clock	6			GHz
		NRZ Data	10.7			Gbps
t_{pd}	Propagation Delay	IN-to-Q	135		285	ps
		SEL-to-Q	100		400	ps
t_{SKEW}	Channel-to-Channel Skew (Within Bank)	Note 7			20	ps
	Part-to-Part Skew	Note 8			75	ps
t_{JITTER}	Clock Cycle-to-Cycle Jitter	Note 9			1	ps _{rms}
	Total Jitter	Note 10			10	ps _{pp}
	Data Random Jitter	Note 11			1	ps _{rms}
	Deterministic Jitter	Note 12			10	ps _{pp}
	Crosstalk Induced Jitter (Adjacent Channel)	Note 13			0.7	ps _{rms}
t_r, t_f	Output Rise/Fall Time	20% to 80%, at full swing.	25		60	ps

Notes:

6. Measured with 100mV input swing. High frequency AC-parameters are guaranteed by design and characterization.
7. Skew is measured between outputs of the same bank under identical transitions.
8. Skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs.
9. Cycle-to-cycle jitter definition: The variation of periods between adjacent cycles, $T_n - T_{n-1}$ where T is the time between rising edges of the output signal.
10. Total jitter definition: With an ideal clock input of frequency $\leq f_{MAX}$, no more than one output edge in 10^{12} output edges will deviate by more than the specified peak-to-peak jitter value.
11. Random jitter is measured with a K28.7 comma detect character pattern, measured at 2.5Gbps–3.2Gbps.
12. Deterministic jitter is measured at 2.5Gbps–3.2Gbps with both K28.5 and $2^{23}-1$ PRBS pattern.
13. Crosstalk induced jitter is defined as the added jitter that results from signals applied to two adjacent channels. It is measured at the output while applying similar, differential clock frequencies that are asynchronous with respect to each other at inputs.

SINGLE-ENDED AND DIFFERENTIAL SWINGS**Figure 1a. Single-Ended Voltage Swing****Figure 1b. Differential Voltage Swing**

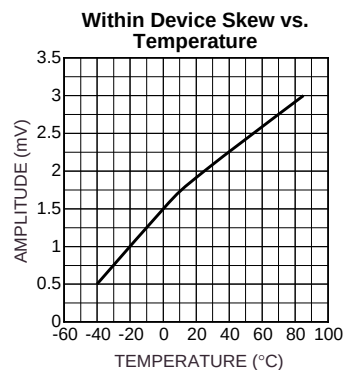
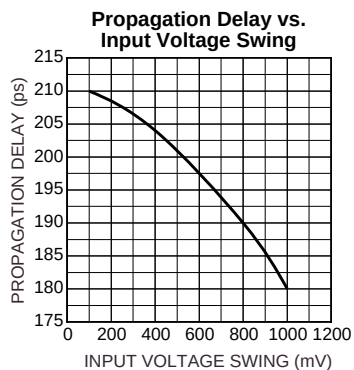
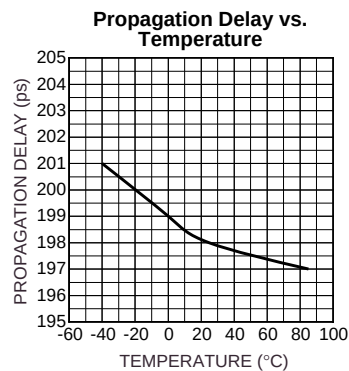
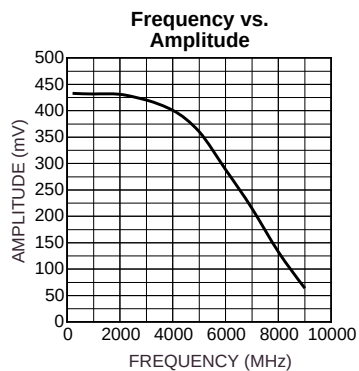
TIMING DIAGRAM**Figure 2a. AC Timing Diagram IN-to-Q**

$IN0, /IN1 = \text{LOW}, /IN0, IN1 = \text{HIGH}$

Figure 2b. AC Timing Diagram SEL-to-Q

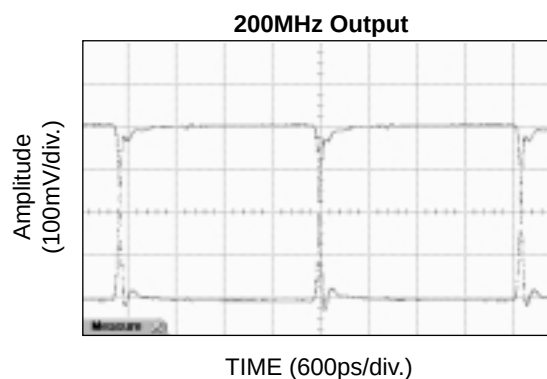
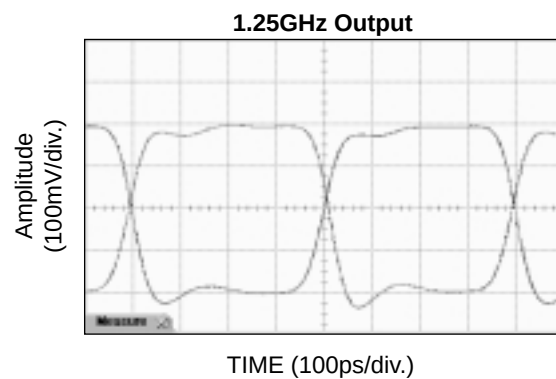
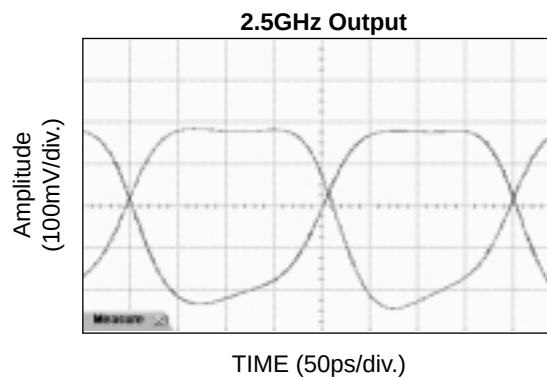
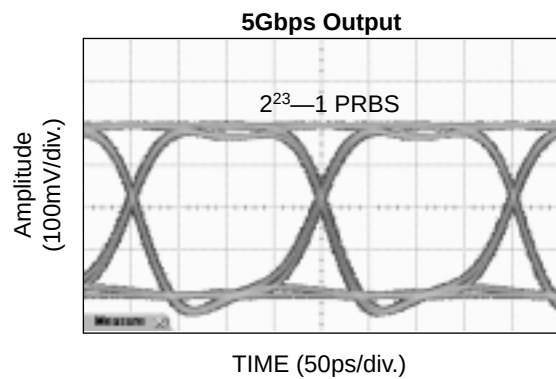
TYPICAL OPERATING CHARACTERISTICS

$V_{CC} = 2.5V$, $V_{IN} = 100mV$, $T_A = 25^\circ C$, unless otherwise noted.



FUNCTIONAL CHARACTERISTICS

$V_{CC} = 2.5V$, $V_{IN} = 100mV$, $T_A = 25^\circ C$, unless otherwise noted.



INPUT STAGE

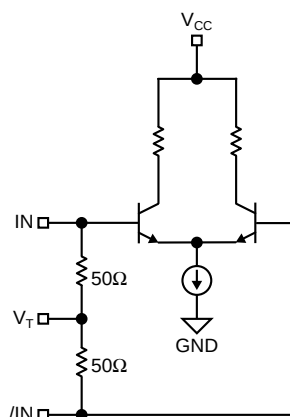
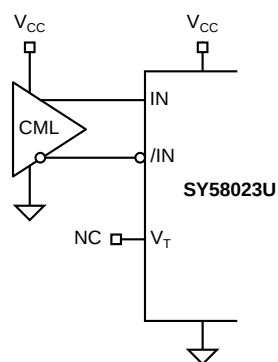
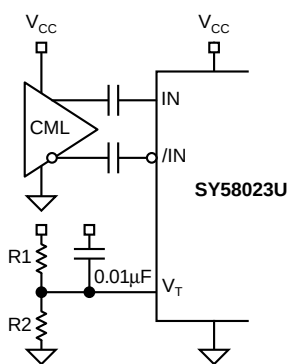


Figure 3. Simplified Differential Input Buffer

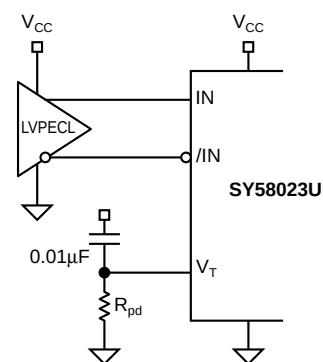
INPUT INTERFACE APPLICATIONS



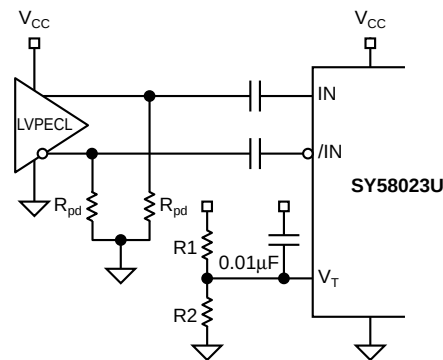
Option: may connect V_T to V_{CC}

Figure 4a. DC-Coupled CML
Input Interface

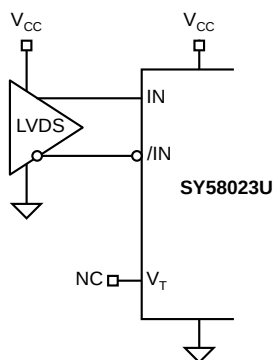
For 2.5V, $R_1 = 1k\Omega$, $R_2 = 1.1k\Omega$.
For 3.3V, $R_1 = 649\Omega$, $R_2 = 1k\Omega$.

Figure 4b. AC-Coupled CML
Input Interface

For $V_{CC} = 2.5V$, $R_{pd} = 19\Omega$.
For $V_{CC} = 3.3V$, $R_{pd} = 50\Omega$.

Figure 4c. DC-Coupled LVPECL
Input Interface

For $V_{CC} = 2.5V$, $R_{pd} = 50\Omega$, $R_1 = 1k\Omega$, $R_2 = 1.1k\Omega$.
For $V_{CC} = 3.3V$, $R_{pd} = 100\Omega$, $R_1 = 649\Omega$, $R_2 = 1k\Omega$.

Figure 4d. AC-Coupled LVPECL
Input InterfaceFigure 4e. LVDS
Input Interface

CML OUTPUT TERMINATION

Figures 5 and Figure 6 illustrates how to terminate a CML output using both the AC-coupled and DC-coupled configuration. All outputs of the SY58023U are 50Ω with a 16mA current source.

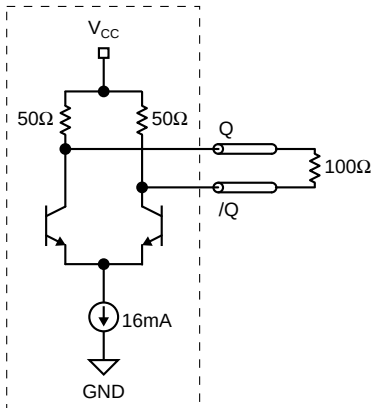


Figure 5. CML DC-Coupled Termination

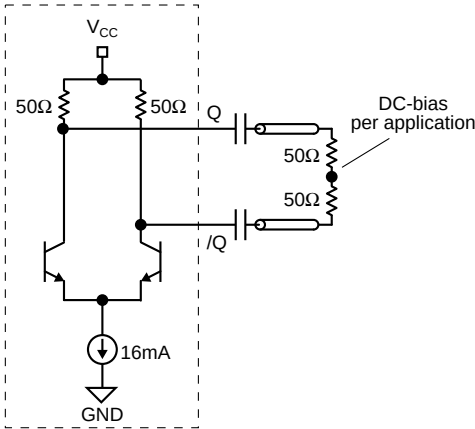
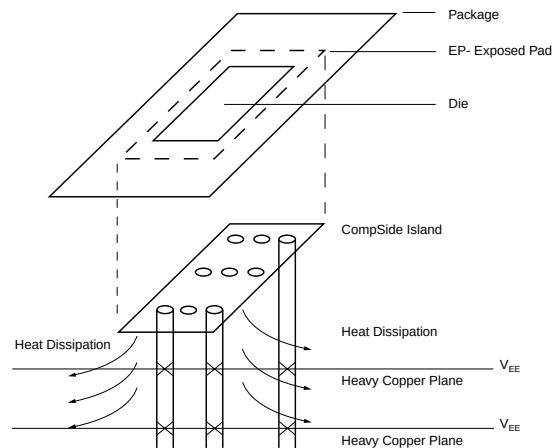
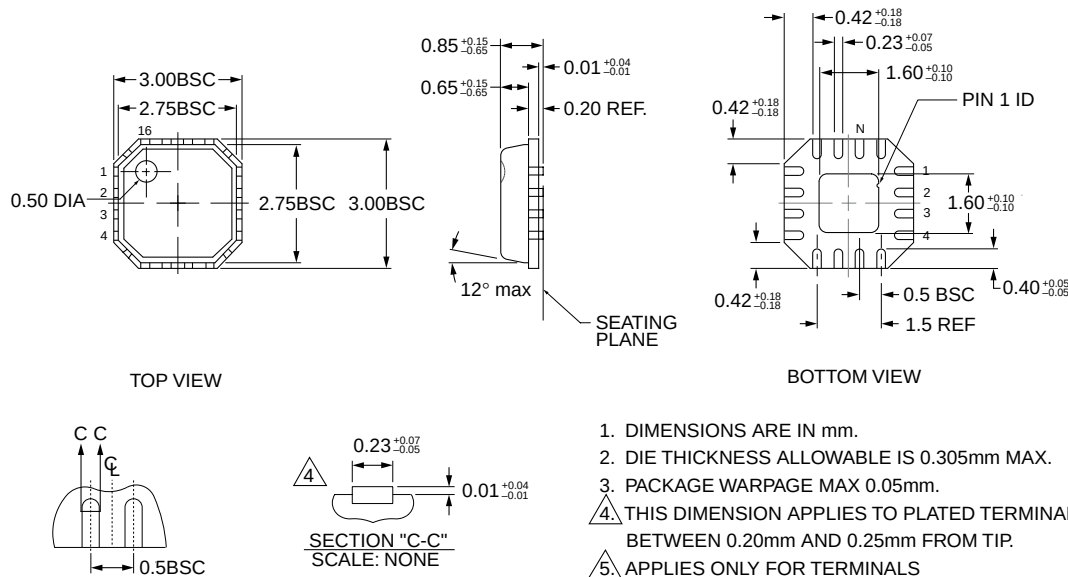


Figure 6. CML AC-Coupled Termination

RELATED PRODUCT AND SUPPORT DOCUMENTATION

Part Number	Function	Data Sheet Link
SY58023U	Ultra-low Jitter 2×2 Crosspoint Switch w/CML Outputs and Internal I/O Termination	http://www.micrel.com/product-info/products/sy58023u.shtml
SY58024U	Ultra-low Jitter Dual 2×2 Crosspoint Switch w/CML Outputs and Internal I/O Termination	http://www.micrel.com/product-info/products/sy58024u.shtml
	16-MLF™ Manufacturing Guidelines Exposed Pad Application Note	www.amkor.com/products/notes_papers/MLF_AppNote.pdf
	HBW Solutions	http://www.micrel.com/product-info/as/solutions.shtml

16 LEAD MicroLeadFrame™ (MLF-16)

Rev. 02

PCB Thermal Consideration for 16-Pin MLF™ Package
(Always solder, or equivalent, the exposed pad to the PCB)

Package Notes:

1. Package meets Level 2 qualification.
2. All parts are dry-packaged before shipment.
3. Exposed pads must be soldered to a ground for proper thermal management.

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